

Baseband Delay Line 64 µs (Improved Version of U3665M)

Application

In TV sets, the integrated baseband delay line circuit is suitable for decoders with color-difference signal outputs

Description

The integrated delay line circuit U3666M is suitable for all chroma decoders with baseband color-difference outputs. It is suitable for PAL-, SECAM- and NTSC-signals as well. The U3666M contains two separate delay lines for processing (R-Y)-output and (B-Y)-output separately. The delay is performed by internally switched capacitors. On-chip postfiltering avoids the need for external filter components. In the case of the U3666M, the postfilter is tuned to Bessel-characteristic.

A summing circuitry combines the information of adjacent TV-lines, thus giving an interpolated sum for the PAL-system, storing preceding lines for the SECAM-system and providing a comb-filtered output for NTSC-signals. Due to internally generated timing, synchronization is easily done by feeding a line-frequent impulse (usually the SC-impulse) to the sync-input of the IC.

Features

- One line delay time, addition of delayed and non-delayed output signals
- Adjustment-free application, VCO without external components
- Handles negative or positive color-difference input signals
- Improved latch-up stability

- Improved power supply rejection ratio (PSRR)
- No crosstalk between SECAM color carriers (diaphoty)
- Comb-filtering functions for NTSC colordifference signals
- Correction of phase errors in the PAL system

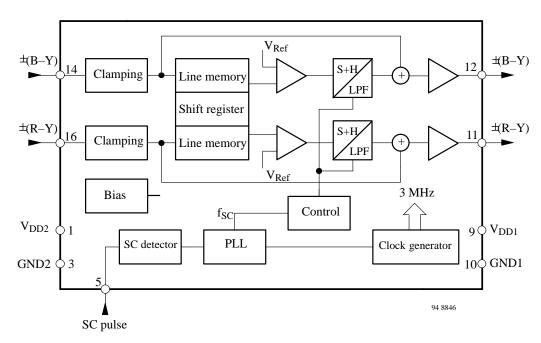


Figure 1. Block diagram

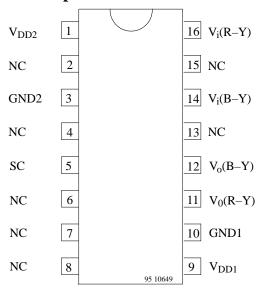
Rev. A1, 10-Feb-97



Ordering Information

| | Extended Type Number | Package | Remarks |
|---|----------------------|---------|---------|
| | U3666M-MDP | DIP16 | |
| Ī | U3666M-MFP | SO16 | |

Pin Description



| Pin | Symbol | Function |
|-----|--------------------|---------------------------------|
| 1 | V_{DD2} | Supply voltage for digital part |
| 2 | NC | Not connected |
| 3 | GND2 | Ground for digital part |
| 4 | NC | Not connected |
| 5 | SC | Sandcastle-pulse input |
| 6 | NC | Not connected |
| 7 | NC | Not connected |
| 8 | NC | Not connected |
| 9 | V_{DD1} | Supply voltage for analog part |
| 10 | GND1 | Ground for analog part |
| 11 | $V_{o (R-Y)}$ | ±(R–Y) output signal |
| 12 | $V_{o (B-Y)}$ | ±(B–Y) output signal |
| 13 | NC | Not connected |
| 14 | $V_{i (B-Y)}$ | ±(B-Y) input signal |
| 15 | NC | Not connected |
| 16 | $V_{i(R-Y)}$ | ±(R-Y) input signal |

Figure 2. Connection diagram

Absolute Maximum Ratings

Reference point Pin 3, 10, unless otherwise specified

| Parameters | Symbol | Min. | Тур. | Max. | Unit |
|--|--------------------|------|------|----------------|------|
| Supply voltage (Pin 9) | V_{DD1} | -0.5 | | +7 | V |
| Supply voltage (Pin 1) | V_{DD2} | -0.5 | | +7 | V |
| Voltage on Pins 5, 11, 12, 14 and 16 | V _n | -0.5 | | V _S | V |
| Output current, (Pin 11, Pin 12) | I _{out} | | | 20 | mA |
| Power dissipation | P | | | 1.1 | W |
| Storage temperature range | T _{stg} | -25 | | +150 | °C |
| Electrostatic protection* for input/ output pins | | | | 500 | V |

^{*} MIL standard 883D, method 3015.7 machine model (all power pins connected together)

Operating Range

| Parameters | Symbol | Value | Unit |
|-------------------------------------|------------------|------------|------|
| Supply-voltage range (Pin 1, Pin 9) | V_s | 4.5 to 5.5 | V |
| Ambient-temperature range | T _{amb} | −10 to +70 | °C |

Thermal Resistance

| Parameters | Symbol | Value | Unit |
|------------------|------------|-------|------|
| Junction ambient | R_{thJA} | 80 | K/W |

2 (9)

TELEFUNKEN Semiconductors

Rev. A1, 10-Feb-97



Electrical Characteristics

 V_{DD} = 5.0 V, T_{amb} = 25°C, reference point, Pin 3 and Pin 10 connected together, sandcastle frequency of 15.625 kHz; unless otherwise specified

| Domentors | Test Conditions / Dins | Crimbal | Min | True | Mon | Linit |
|--|--|-----------------------------------|---------------------|----------------------|---------------------|----------|
| Parameters DC annulu | Test Conditions / Pins | Symbol | Min. | Тур. | Max. | Unit |
| DC-supply | Pin 1, 9 | 3.7 | 4.5 | 5.0 | <i></i> | 3.7 |
| Supply voltage (analog part) | Pin 9 | V _{DD1} | 4.5 | 5.0 | 5.5 | V |
| Supply voltage (digital part) | Pin 1 | V _{DD2} | 4.5 | 5.0 | 5.5 | V |
| Supply current (analog part) | Pin 9 | I _{S1} | | 3.5 | 8.0 | mA |
| Supply current (digital part) | Pin 1 | I _{S2} | | 1 | 2 | mA |
| Power dissipation | | P | | 30 | 60 | mW |
| Color-difference input signal | s Pin 14, 16 | | 1 | | | |
| Input signal | | | | | | |
| (peak-to-peak value) ±(R-Y) PAL and NTSC | Pin 16 | V _i | | 0.525 | 1.0 | V |
| \pm (B-Y) PAL and NTSC | Pin 14 | 1 | | 0.525 | 1.0 | V |
| | | V _i | | | | V |
| ±(R-Y) SECAM | Pin 16 | Vi | | 1.05 | 2.0 | |
| ±(B–Y) SECAM | Pin 14 | V _i | | 1.33 | 2.0 | V |
| Input resistance | During clamping | R ₁₄ , R ₁₆ | | | 40 | kΩ |
| Input capacitance | N | C ₁₄ , C ₁₆ | | 1.15 | 10 | pF |
| Input clamping voltage | Non color input level | V ₁₄ | | 1.45 | | V |
| Colon difference and stand signs | during clamping | V ₁₆ | | | | |
| Color-difference output signal Output signal | nls Pin 11, 12 | | | | | |
| (peak-to-peak value) ±(R-Y) | All standards Pin 11 | V _o | | 1.05 | | V |
| ±(B-Y) | All standards Pin 12 | V _o | | 1.33 | | V |
| Ratio of output amplitudes at | 7111 Standards 1 111 12 | V ₁₁ /V ₁₂ | -0.4 | 0 | +0.4 | dB |
| equal input signals | | | -0.4 | | +0.4 | |
| DC output voltage | Pin 11, 12 | V _{11,12} | | 3.0 | | V |
| Output resistance | Pin 11, 12 | R _{11,12} | | | 400 | Ω |
| Gain for PAL and NTSC | Ratio V _o / V _i | G_{v} | 5.5 | 6.0 | 6.5 | dB |
| Gain for SECAM | Ratio V _o / V _i | G_{v} | -0.5 | 0 | +0.5 | dB |
| Ratio of output signals for | $V_{i 14,16} = 1.33V_{pp},$ | $V_{(n)}$ | | ±0.1 | | dB |
| adjacent time samples at | SECAM signals, | $V_{(n+1)}$ | | | | |
| constant input signals | Pin 11 / Pin 12 | | | | | |
| Noise voltage | $V_{i 14,16} = 0, R_{gen} < 300 \Omega$ | V _{noise} | | | 1.2 | mV |
| (RMS value) | f = 10 kHz to 1 MHz | | | | | |
| Delay of delayed signals | Pin 11, 12 | | 63.94 | 64.0 | 64.06 | He |
| Delay of non-delayed signals | | t _d | 03.94 | 65 | 04.00 | μs |
| Transient time of delayed | 300 ns transient of SECAM | t _d | | 550 | | ns |
| signal | input signal, C _{load} = 22 pF | t _{tr} | | 330 | | ns |
| Signai | Pin 11, 12 | | | | | |
| Transient time of | 300 ns transient of SECAM | t _{tr} | | 350 | | ns |
| non-delayed signal | input signal, C _{load} = 22 pF | | | | | |
| | Pin 11, 12 | | | | | |
| Sandcastle-pulse input Pin 5 | | | | | | |
| Sandcastle frequency | | f _{SC} | 14.0 | 15.625 | 17.0 | kHz |
| Top pulse voltage | The leading edge of the burst- key pulse is used for timing | V ₅ | 3 | | Vs+0.7 | V |
| Internal slicing level | | V _{slice} | V ₅ -1.5 | V ₅ -1.25 | V ₅ -1.0 | V |
| Input current | | I ₅ | | | 10 | μΑ |
| Input capacitance | | | | | 10 | |
| | | C ₅ | | | | μA pF |

TELEFUNKEN Semiconductors

Rev. A1, 10-Feb-97

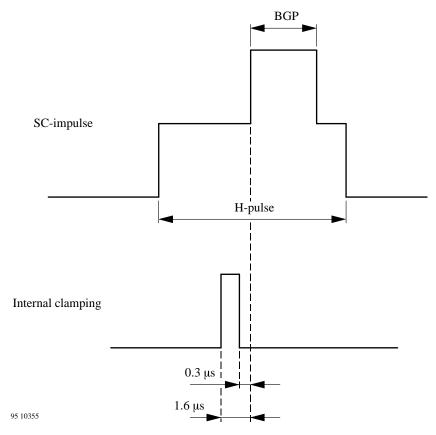


Figure 3. Timing of internal clamping

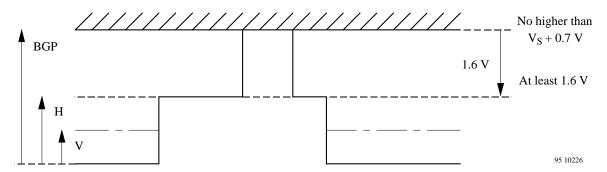


Figure 4. Restrictions to SC pulse

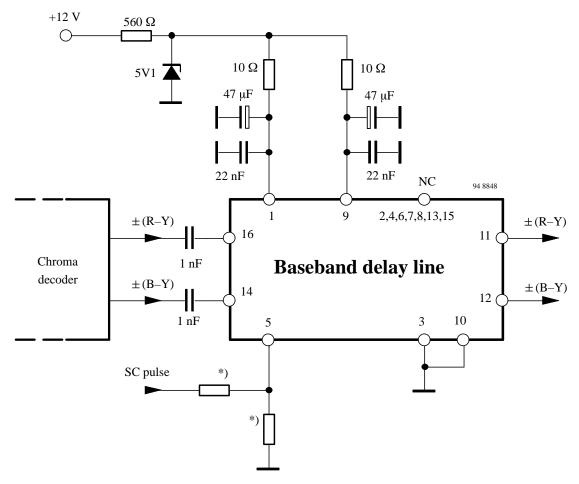


Figure 5. Typical application circuit

*)Depends on application (5 V - or 12 V SC pulse)

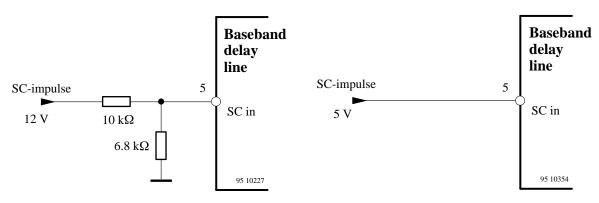


Figure 6. Application with 12 V SC-pulse

Figure 7. Application with 5 V SC-pulse

TELEFUNKEN Semiconductors

Rev. A1, 10-Feb-97



Internal Pin Circuits

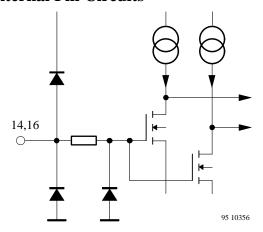


Figure 8. Color-difference signal inputs

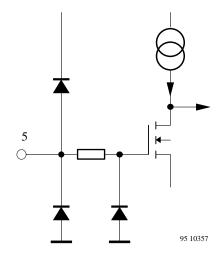


Figure 10. Sandcastle-pulse input

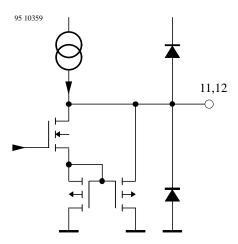


Figure 9. Color-difference signal outputs

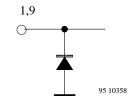
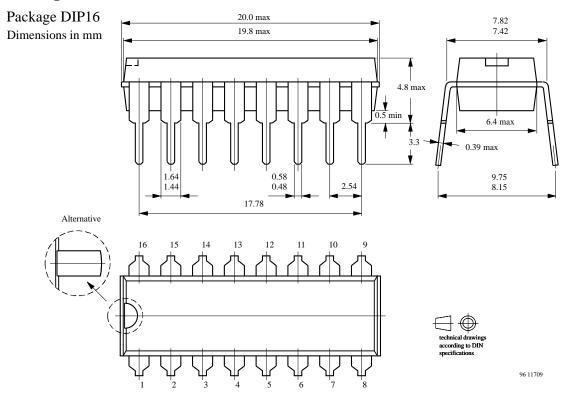


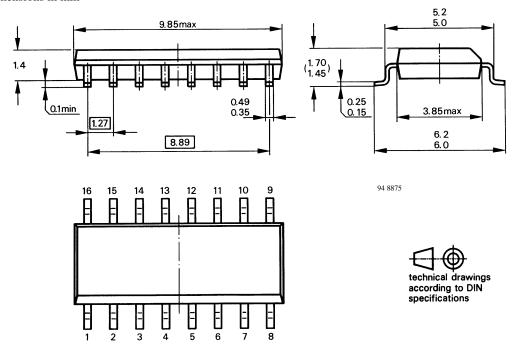
Figure 11. Supply voltage $V_{DD2},\,V_{DD1}$



Package Information



Package SO16 Dimensions in mm



TELEFUNKEN Semiconductors

Rev. A1, 10-Feb-97



Ozone Depleting Substances Policy Statement

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

TEMIC TELEFUNKEN microelectronic GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423

TELEFUNKEN Semiconductors

Rev. A1, 10-Feb-97

8 (9)